

V_{DSS}	600V
$R_{DS(on)}(Max.)$	0.29Ω
I_D	±15A
P_D	184W

●Features

- 1) Low on-resistance.
- 2) Ultra fast switching speed.
- 3) Parallel use is easy.
- 4) Pb-free lead plating ; RoHS compliant

●Application

Switching

●Outline

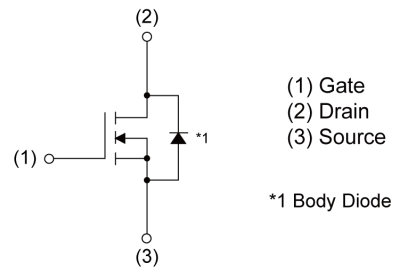
TO-263

SC-83

LPT(S)



●Inner circuit



●Packaging specifications

Type	Packing	Embossed Tape
	Reel size (mm)	330
	Tape width (mm)	24
	Basic ordering unit (pcs)	1000
	Taping code	TL
	Marking	R6015KNJ

●Absolute maximum ratings ($T_a = 25^\circ\text{C}$, unless otherwise specified)

Parameter		Symbol	Value	Unit
Drain - Source voltage		V_{DSS}	600	V
Continuous drain current ($T_c = 25^\circ\text{C}$)		I_D^{*1}	±15	A
Pulsed drain current		I_{DP}^{*2}	±45	A
Gate - Source voltage	static	V_{GSS}	±20	V
	AC($f > 1\text{Hz}$)		±30	V
Avalanche current, single pulse		I_{AS}	2.4	A
Avalanche energy, single pulse		E_{AS}^{*3}	284	mJ
Power dissipation ($T_c = 25^\circ\text{C}$)		P_D	184	W
Junction temperature		T_j	150	°C
Operating junction and storage temperature range		T_{stg}	-55 to +150	°C

● Thermal resistance

Parameter	Symbol	Values			Unit
		Min.	Typ.	Max.	
Thermal resistance, junction - case	R_{thJC}^{*4}	-	-	0.68	°C/W
Thermal resistance, junction - ambient	R_{thJA}^{*5}	-	-	80	°C/W
Soldering temperature, wavesoldering for 10s	T_{sold}	-	-	265	°C

● Electrical characteristics ($T_a = 25^\circ\text{C}$)

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Drain - Source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 1mA$	600	-	-	V
Zero gate voltage drain current	I_{DSS}	$V_{DS} = 600V, V_{GS} = 0V$ $T_j = 25^\circ\text{C}$	-	-	100	μA
		$T_j = 125^\circ\text{C}$	-	-	1000	
Gate - Source leakage current	I_{GSS}	$V_{GS} = \pm 20V, V_{DS} = 0V$	-	-	± 100	nA
Gate threshold voltage	$V_{GS(th)}$	$V_{DS} = 10V, I_D = 1mA$	3	-	5	V
Static drain - source on - state resistance	$R_{DS(on)}^{*6}$	$V_{GS} = 10V, I_D = 6.5A$ $T_j = 25^\circ\text{C}$	-	0.26	0.29	Ω
		$T_j = 125^\circ\text{C}$	-	0.56	-	
Gate resistance	R_G	$f = 1MHz, \text{open drain}$	-	2.3	-	Ω

●Electrical characteristics ($T_a = 25^\circ\text{C}$)

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Forward Transfer Admittance	$ Y_{fs} ^{*6}$	$V_{DS} = 10\text{V}, I_D = 7.5\text{A}$	4.0	8.0	-	S
Input capacitance	C_{iss}	$V_{GS} = 0\text{V}$	-	1050	-	pF
Output capacitance	C_{oss}	$V_{DS} = 25\text{V}$	-	900	-	
Reverse transfer capacitance	C_{rss}	$f = 1\text{MHz}$	-	40	-	
Turn - on delay time	$t_{d(on)}^{*6}$	$V_{DD} \approx 300\text{V}, V_{GS} = 10\text{V}$	-	30	-	ns
Rise time	t_r^{*6}	$I_D = 7.5\text{A}$	-	30	-	
Turn - off delay time	$t_{d(off)}^{*6}$	$R_L \approx 40.2\Omega$	-	50	-	
Fall time	t_f^{*6}	$R_G = 10\Omega$	-	15	-	

●Gate charge characteristics ($T_a = 25^\circ\text{C}$)

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Total gate charge	Q_g^{*6}	$V_{DD} \approx 300\text{V}$	-	27.5	-	nC
Gate - Source charge	Q_{gs}^{*6}	$I_D = 15\text{A}$	-	7.5	-	
Gate - Drain charge	Q_{gd}^{*6}	$V_{GS} = 10\text{V}$	-	12	-	
Gate plateau voltage	$V_{(plateau)}$	$V_{DD} \approx 300\text{V}, I_D = 15\text{A}$	-	6.6	-	V

*1 Limited only by maximum channel temperature allowed.

*2 $P_w \leq 10\mu\text{s}$, Duty cycle $\leq 1\%$

*3 $L \doteq 100\text{mH}$, $V_{DD}=50\text{V}$, $R_G=25\Omega$, STARTING $T_j=25^\circ\text{C}$

*4 $T_C=25^\circ\text{C}$

*5 Mounted on a epoxy PCB FR4 (25mm x 27mm x 0.8mm)

*6 Pulsed

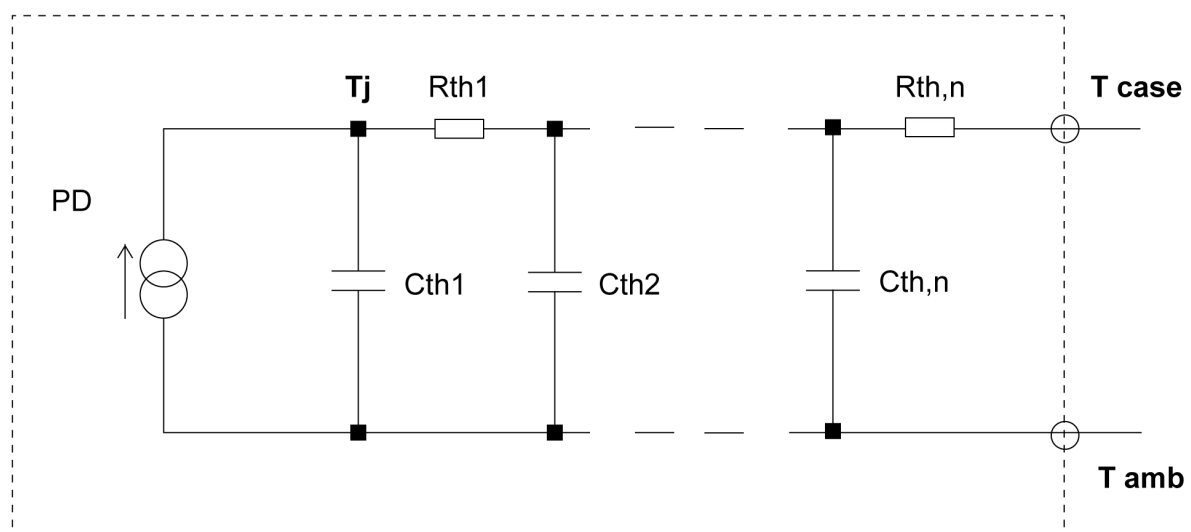
●Body diode electrical characteristics (Source-Drain) ($T_a = 25^\circ\text{C}$)

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Continuous forward current	I_S^{*1}	$T_C = 25^\circ\text{C}$	-	-	15	A
Pulse forward current	I_{SP}^{*2}		-	-	45	A
Forward voltage	V_{SD}^{*6}	$V_{GS} = 0\text{V}, I_S = 15\text{A}$	-	-	1.5	V
Reverse recovery time	t_{rr}^{*6}	$I_S = 15\text{A}$ $di/dt = 100\text{A}/\mu\text{s}$	-	415	-	ns
Reverse recovery charge	Q_{rr}^{*6}		-	5.0	-	μC
Peak reverse recovery current	I_{rm}^{*6}		-	24	-	A

●Typical transient thermal characteristics

Symbol	Value	Unit
R_{th1}	0.0929	K/W
R_{th2}	0.365	
R_{th3}	0.615	

Symbol	Value	Unit
C_{th1}	0.00162	Ws/K
C_{th2}	0.00548	
C_{th3}	0.176	



●Electrical characteristic curves

Fig.1 Power Dissipation Derating Curve

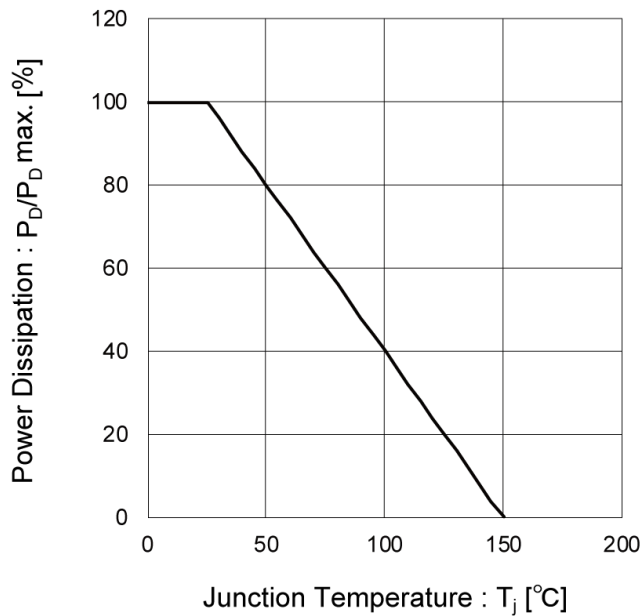


Fig.2 Maximum Safe Operating Area

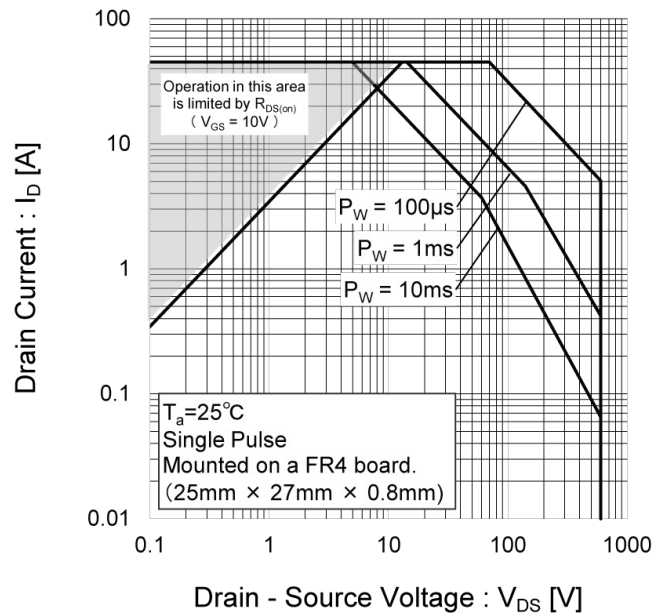
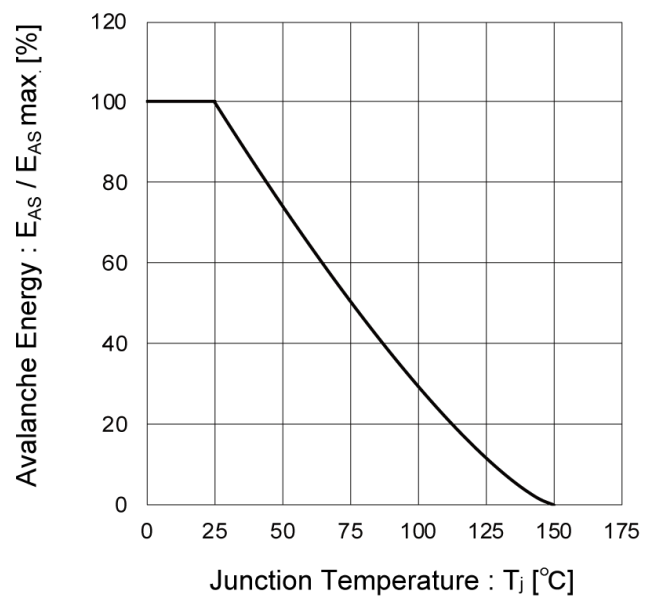


Fig.3 Avalanche Energy Derating Curve vs. Junction Temperature



●Electrical characteristic curves

Fig.4 Typical Output Characteristics(I)

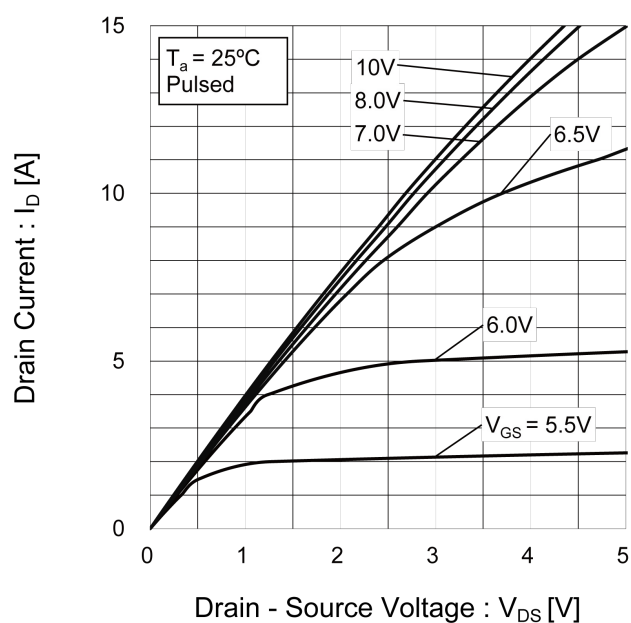
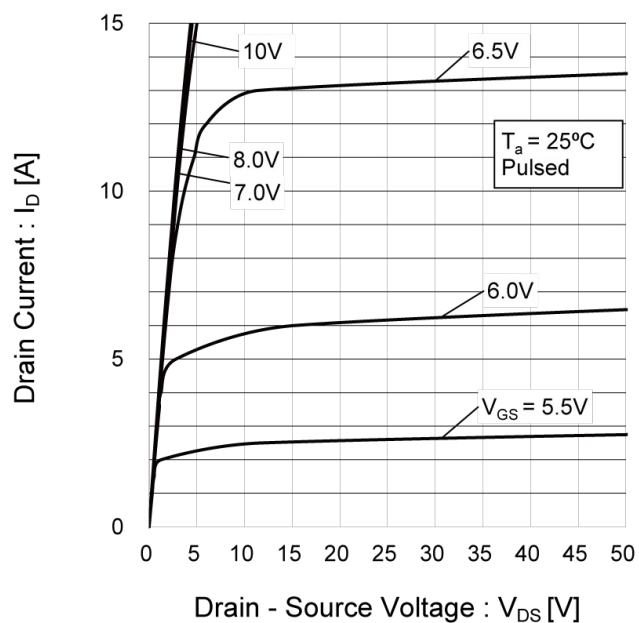


Fig.5 Typical Output Characteristics(II)



●Electrical characteristic curves

Fig.6 Breakdown Voltage vs.
Junction Temperature

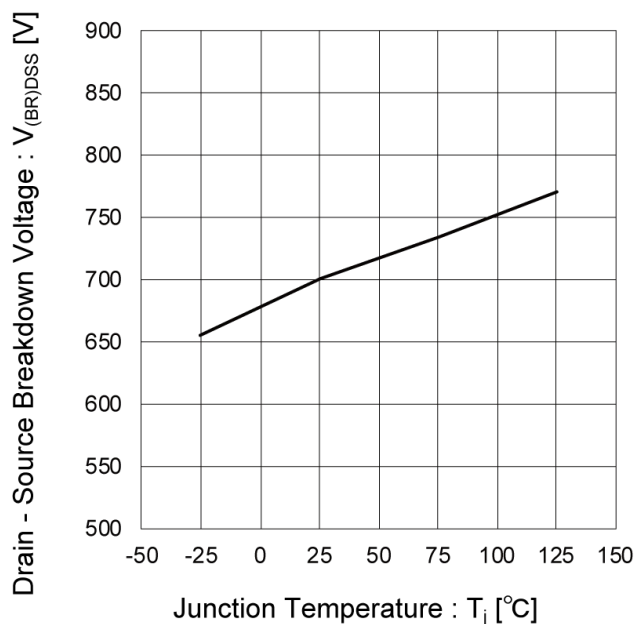


Fig.7 Typical Transfer Characteristics

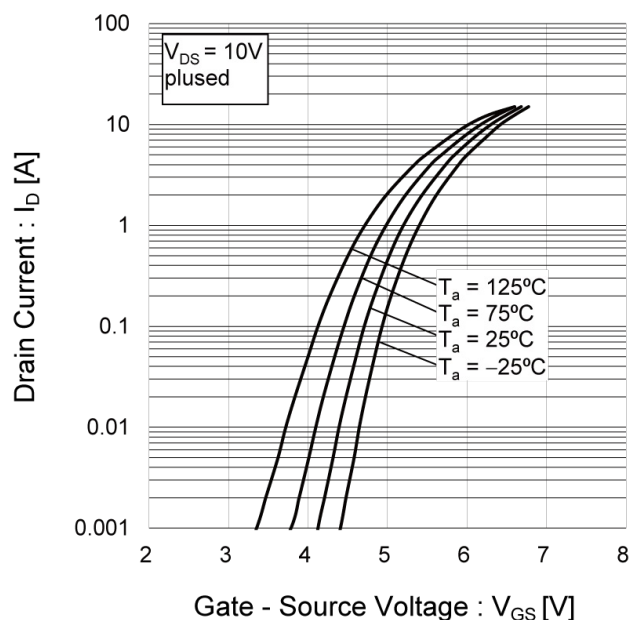


Fig.8 Gate Threshold Voltage vs.
Junction Temperature

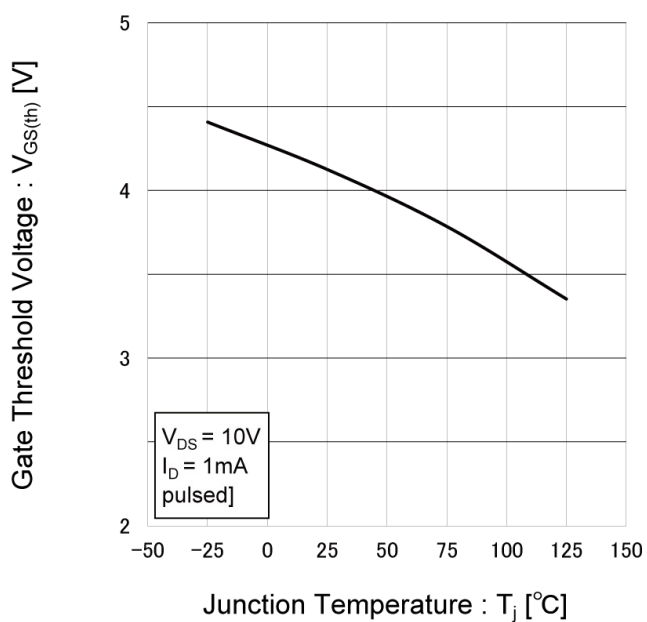
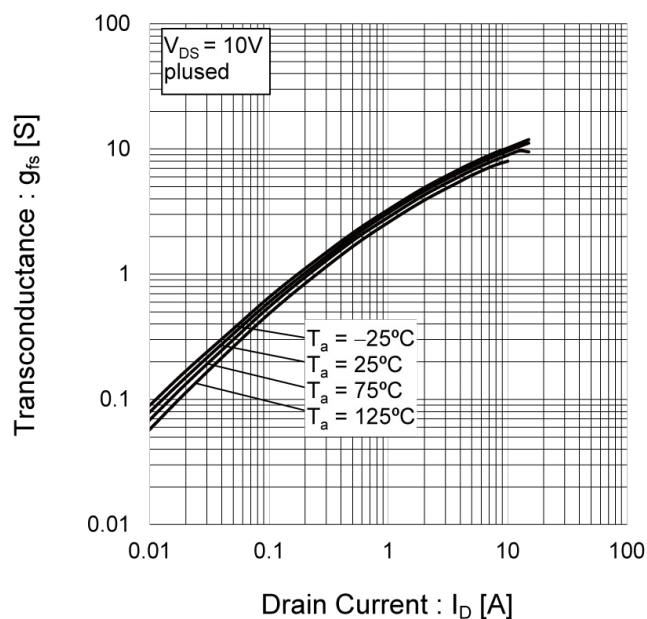


Fig.9 Forward Transfer Admittance vs.
Drain Current



●Electrical characteristic curves

Fig.10 Static Drain - Source On - State Resistance vs. Gate Source Voltage

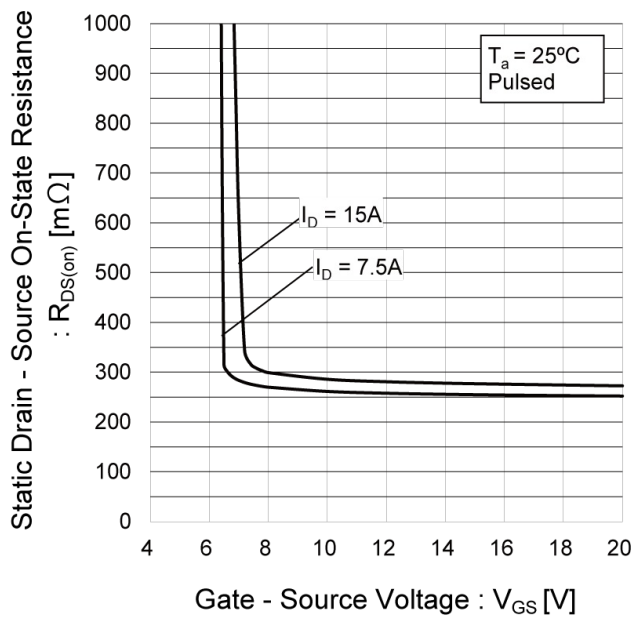


Fig.11 Static Drain - Source On - State Resistance vs. Junction Temperature

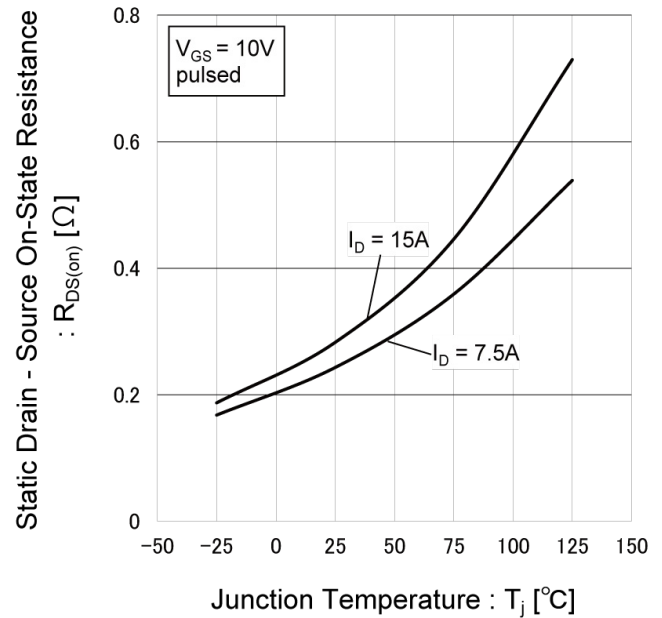
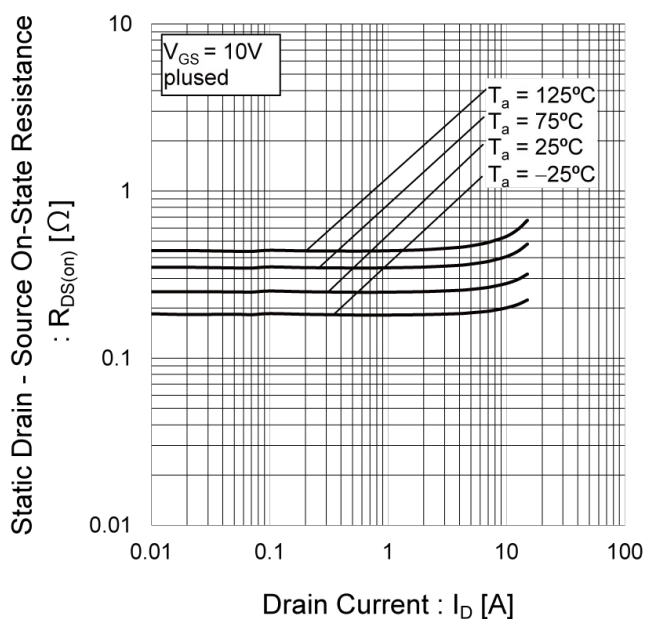


Fig.12 Static Drain - Source On - State Resistance vs. Drain Current(I)



●Electrical characteristic curves

Fig.13 Typical Capacitance vs.
Drain - Source Voltage

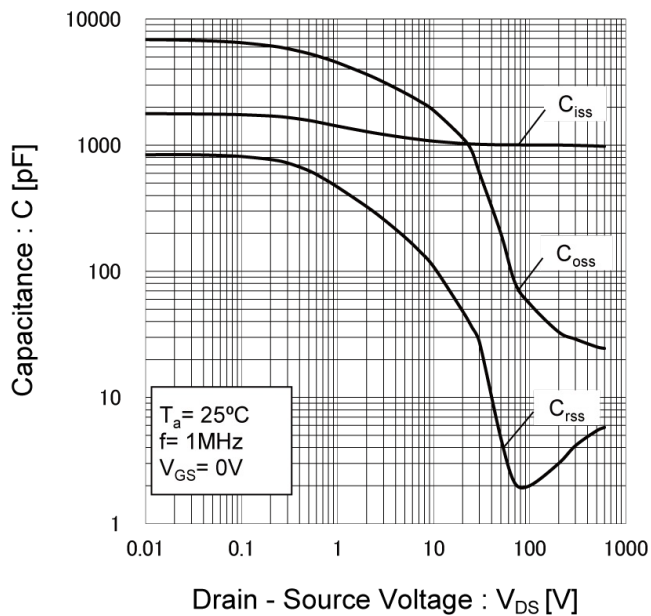


Fig.14 Switching Characteristics

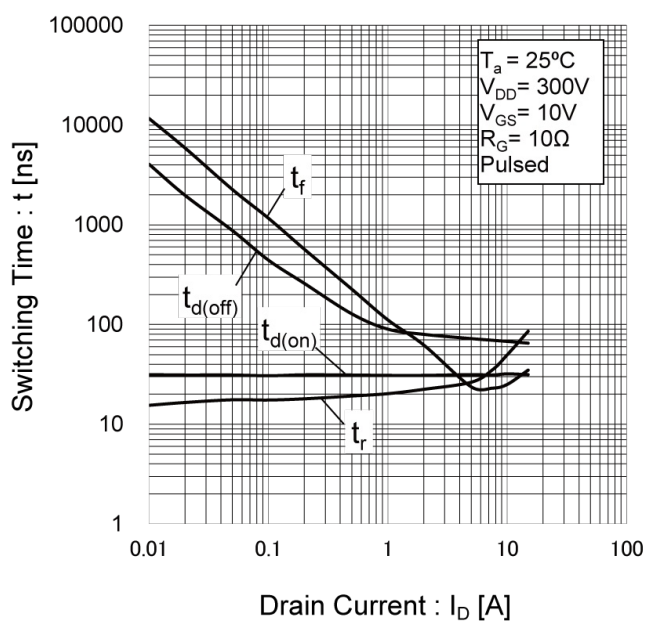
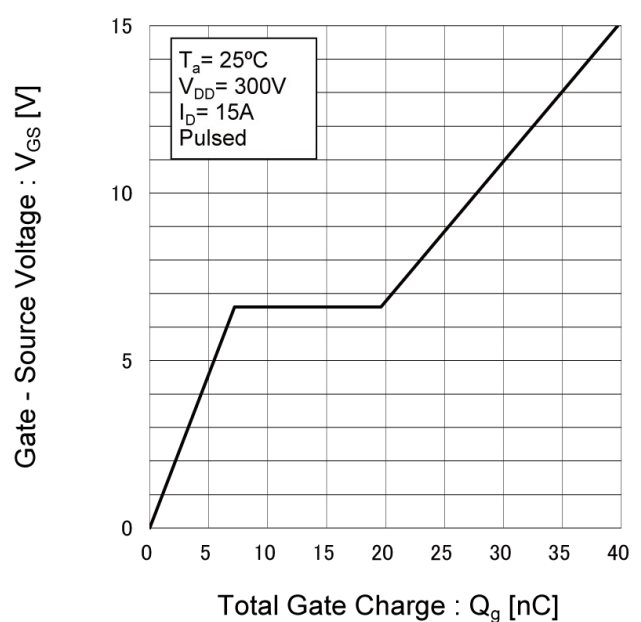


Fig.15 Dynamic Input Characteristics



●Electrical characteristic curves

Fig.16 Inverse Diode Forward Current
vs. Source - Drain Voltage

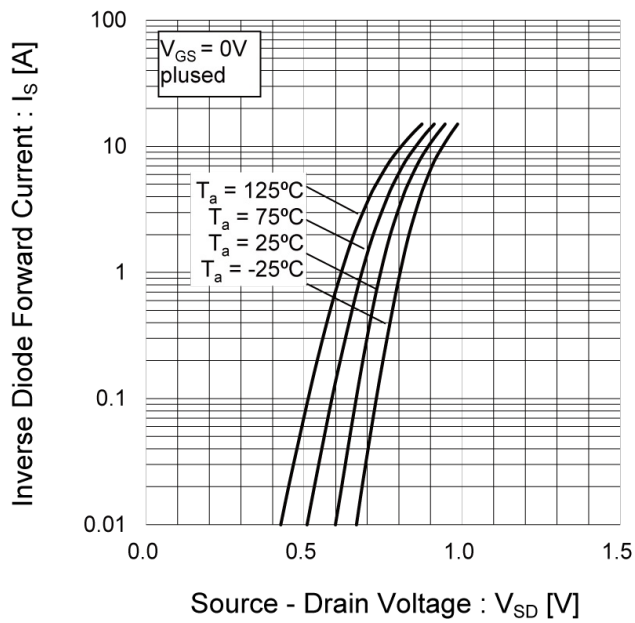
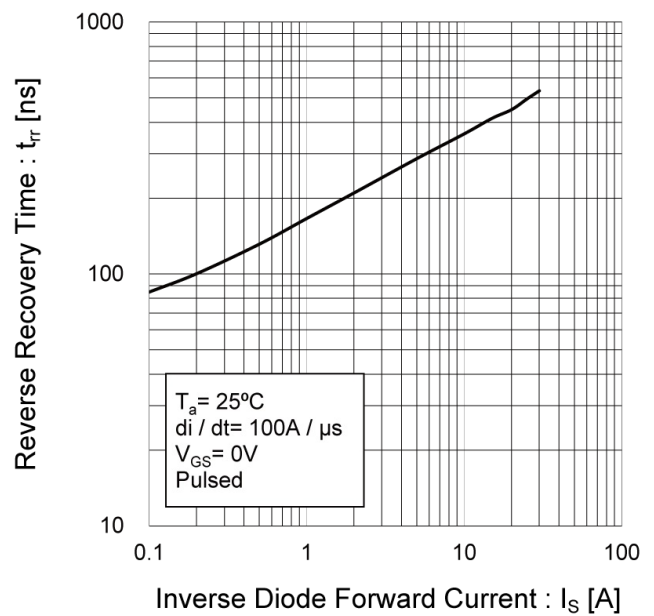


Fig.17 Reverse Recovery Time vs.
Inverse Diode Forward Current



● Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

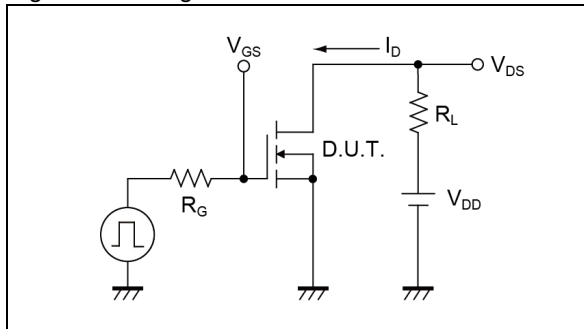


Fig.1-2 Switching Waveforms

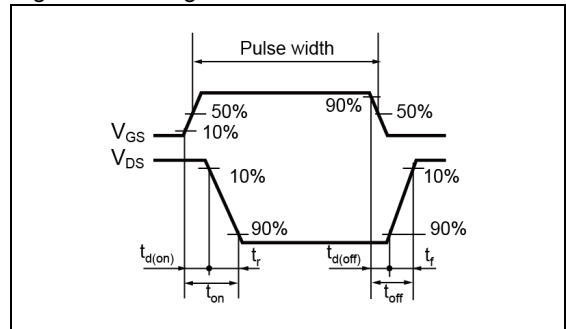


Fig.2-1 Gate Charge Measurement Circuit

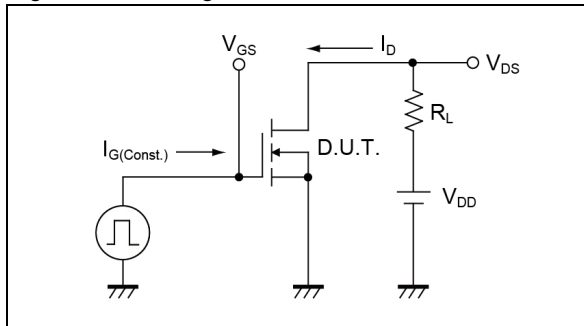


Fig.2-2 Gate Charge Waveform

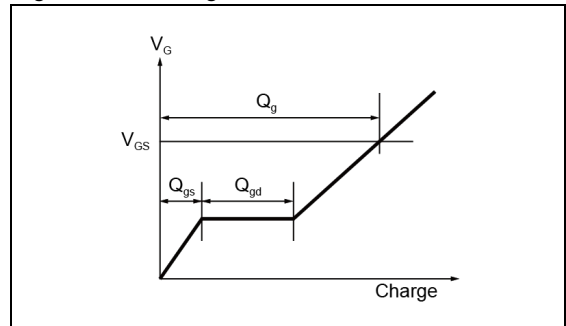


Fig.3-1 Avalanche Measurement Circuit

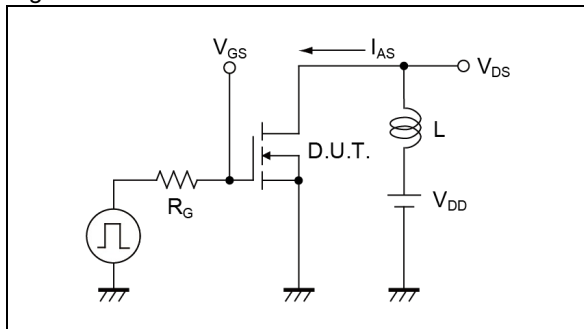


Fig.3-2 Avalanche Waveform

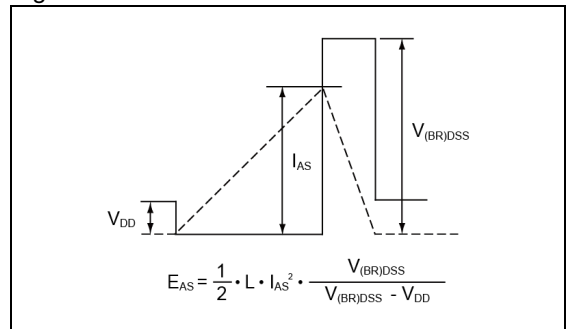


Fig.4-1 dv/dt Measurement Circuit

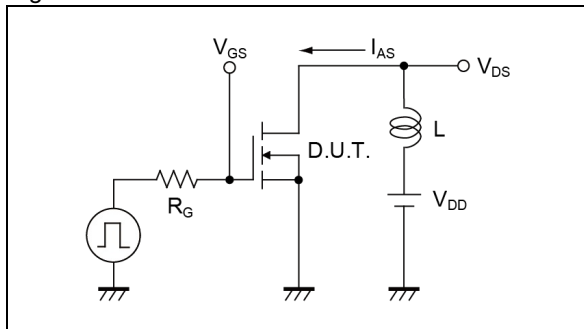


Fig.4-2 dv/dt Waveform

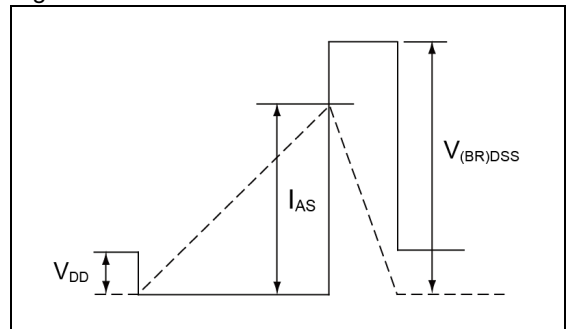


Fig.5-1 dv/dt Measurement Circuit

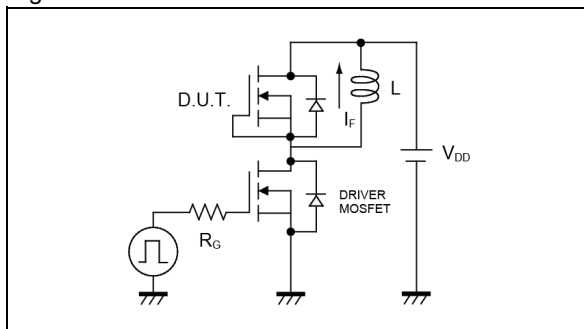
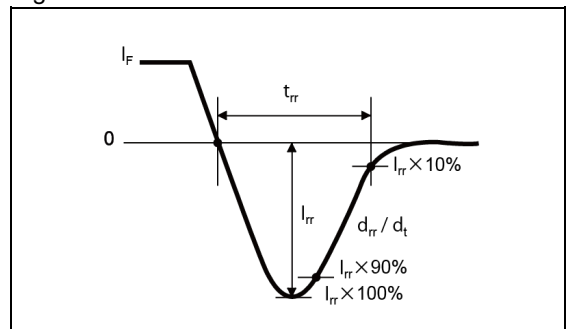
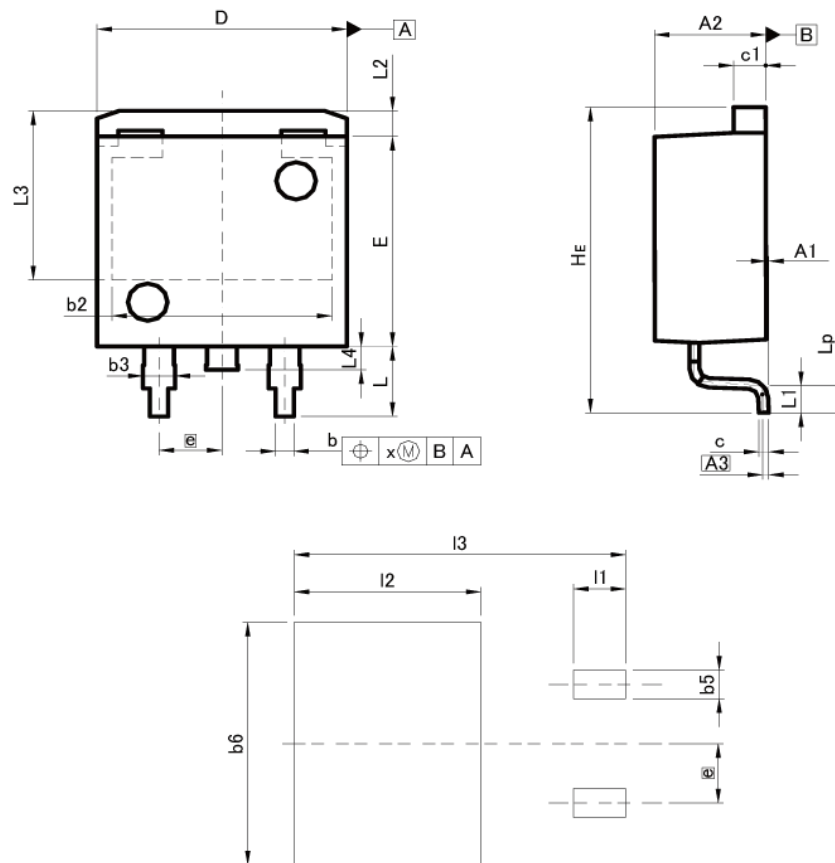


Fig.5-2 dv/dt Waveform



●Dimensions

LPTS
< TO-263 >
(D2PAK)



Pattern of terminal position areas
[Not a pattern of soldering pads]

DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A1	0.00	0.30	0.000	0.012
A2	4.30	4.70	0.169	0.185
A3	0.25		0.010	
b	0.68	0.98	0.027	0.039
b2	8.90		0.350	
b3	1.14	1.44	0.045	0.057
c	0.30	0.60	0.012	0.024
c1	1.10	1.50	0.043	0.059
D	9.80	10.40	0.386	0.409
E	8.80	9.20	0.346	0.362
e	2.54		0.100	
HE	12.80	13.40	0.504	0.528
L	2.70	3.30	0.106	0.130
L1	0.90	1.50	0.035	0.059
L2	1.10		0.043	
L3	7.25		0.285	
L4	1.00		0.039	
Lp	0.90	1.50	0.035	0.059
x	-	0.25	-	0.010

DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
b5	-	1.23	-	0.049
b6	-	10.40	-	0.409
l1	-	2.10	-	0.083
l2	-	7.55	-	0.297
l3	-	13.40	-	0.528

Dimension in mm/inches

Notes

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R6015KNJ - Web Page

[Distribution Inventory](#)

Part Number	R6015KNJ
Package	LPTS(D2PAK)
Unit Quantity	1000
Minimum Package Quantity	1000
Packing Type	Taping
Constitution Materials List	inquiry
RoHS	Yes